

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	14	("5414293" "5652463" "5692296" "5760467" "5905301" "5909057").PN. OR ("6232652").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/05/11 15:28
L3	9	("5889323" "5893726" "5909057" "6054008" "6057597" "6232652" "6300673" "6313521" "6335563").PN. OR ("6445062").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/05/11 15:34
L5	124	((substrate pcb board) and (IC integrated adj circuit die chip semiconductor wafer) and (lid cover) and (tape sealant glue ahesive) and (pattern break hole)).clm.	US-PGPUB	OR	ON	2006/05/11 16:46
L6	73	(257/683).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:20
L7	2823	(257/778).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:43
L8	754	(257/796).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:43
L9	1566	(438/108).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:43
L10	999	(438/124).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/11 16:43
L11	896	(7 8 9 10) and ((substrate pcb board) and (IC integrated adj circuit die chip semiconductor wafer) and (lid cover) and (tape sealant glue ahesive) and (pattern break hole))	US-PGPUB; USPAT	OR	ON	2006/05/11 16:55
L12	402	11 and package.ab.	US-PGPUB; USPAT	OR	ON	2006/05/11 16:55